3.3V Surface Mount 7.5x5mm **Crystal Clock Oscillator** HSM9



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The Connor-Winfield HSM943, HSM933, HSM923, and HSM913 are 7.5mm x 5mm. 3.3V LVCMOS, Surface Mount, Fixed Frequency Crystal Oscillators (XO) designed for use in all applications requiring precision clocks. The RoHS compliant surface mount package is designed for high-density mounting and is optimum for mass production

Features:

1.544 to 170 MHz 3.3V Operation

RoHS Compliant

Tri-State Enable/Disable

Power Saving Function: 10uA When Disabled

Overall Frequency Tolerance:

HSM943 ± 20 ppm, HSM923 ± 50 ppm, $HSM913 \pm 25 ppm$ $HSM933 \pm 100 \text{ ppm}$

Temperature Range: -10 to 70°C Ceramic Surface Mount Package Tape and Reel Packaging

Absolute Maximum Ratings

Parameter	Minimum	Nominal	Maximum	Units	Notes
Storage Temperature	-55	-	125	°C	
Supply Voltage (Vcc)	-0.5	-	7.0	Vdc	

Operating Specifications					
Parameter	Minimum	Nominal	Maximum	Units	Notes
Frequency Range (Fo) HSM943 HSM913 HSM923 HSM933	1.544	-	125 & 155.52 170 170 170	MHz	
Frequency Tolerance HSM943 HSM913 HSM923 HSM933	-20 -25 -50 -100	-	20 25 50 100	ppm	1
Operating Temp Range	-10	-	70	°C	
Supply Voltage (Vdd)	2.97	3.3	3.63	Vdc	
Supply Current (Icc) 1.544 to 31.999 MHz 32 to 49.999 MHz 50 to 66.999 MHz 67 to 124.999 MHz 125 to 170 MHz	-	-	15 20 25 40 50	mA	

Input Characteristics					
Parameter	Minimum	Nominal	Maximum	Units	Notes
Enable Voltage - (Vih)	≥ 70% Vdd	-	-	Vdc	2
Disable Voltage - (Vil)	-	-	≤ 30% Vdd	Vdc	
Enable Time	-	-	10	mS	
Disable Time	-	-	150	nS	
Output Disable Current (Icc)	-	-	10	uA	

LVCMOS Output Characteristics					
Parameter	Minimum	Nominal	Maximum	Units	Notes
Load	-	-	15	pF	
Voltage High (Voh) Low (Vol)	2.91 -	-	0.33	Vdc	
Current High (loh) Low (lol)	-2 -	-	2	mA	
Duty Cycle at 50% of Vcc	45	50	55	%	
Rise / Fall Time: 10% to 90% 0.8V to 2.4V 20% to 80%	- - -	- 1 1	6 1.5 2	nS	
Start-Up Time	-	-	10	mS	
Jitter (10 Hz to 20 MHz) (12 kHz to 20 MHz)	-	- -	5 1	pS RMS pS RMS	

COMPLIANT

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1. Inclusive of calibration @ 25°C, frequency vs temperature stability, supply voltage change, load change, shock and vibration, 15 years aging.

2. Oscillator output is enabled with no connection on pad 1



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Package Characteristics

Hermetically sealed ceramic package and metal cover Package

Environmental Characteristics

The specimen shall meet electrical characteristics after tested 5 cycles of -55°C / 30 minutes and +125°C / 30 minutes Temperature Cycle

No bubbles appear in Flourinert (FC-43) at 125°C ±5°C for 5 minutes Hermetical

Marking will withstand immersion in Isopropyl Alcohol or Trichloroethylene Solvent Resistance

Soldering

General Conditions 260°C max x 10 sec max x 2 times max or 230°C max x 180 sec max x 1 time

(Vapor phase reflow) 20 to 100 sec up to 215°C, 50 sec Typical Operation Data

at 215°C, then down to room temperature per 1 to 5°C / sec

Mechanical Characteristics

The specimen shall meet electrical characteristics after tested 3 times, Free Drop Free Drop testing on the hard wooden board from a height of 75 cm.

The specimen shall meet electrical characteristics after tested by the following conditions: 10-55Hz 1.5mm Amplitude, 55-2000 Hz 20 G's, 2 hours for each plane Vibration

Thermal Shock

After applied Thermal Shock of 260°C max x 10 sec max x 2 times, or 230°C max x 180 sec max, the specimen shall meet electrical characteristics

Solderability

(EIAJ-RCX-0102.101 Condition 1a)
) Flux: MIL-F-14256 (WW Rosin=25%, Isopropyl Alcohol = 75%)
) Solder: QQ-S-571 (Sn = 63%, Pb = 37%)
) Solder bath temperature: 235°C ±5°C
) Depth of immersion: Up to electrical terminal
) Immersing time: Within 2 sec ±0.5 sec into solder bath

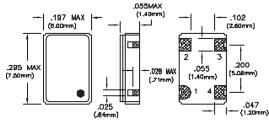
Pin Connections

1: Tri-State E/D 2: Ground

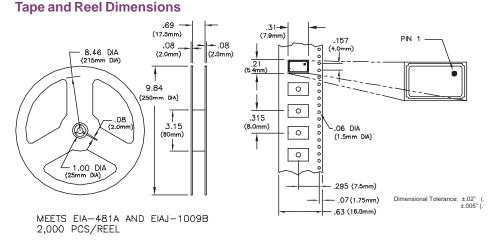
3: Output

4: VDD

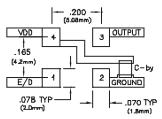
After performing the above procedures, a newly soldered coverage shall be greater than 90%



Dimensional Tolerance: ±.02" (.508mm) ±.005" (.127mm)

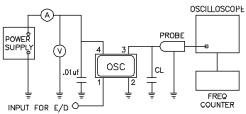


Suggested Pad Layout

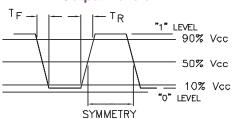


Bypass capacitor, C-by, should be caramic capacitor > .01uf.

Test Circuit



Output Waveform



Marking Information

Part Number	Marking Variations
HSM913	HSM913XX
	HM913XX
HSM923	HSM923XX
	HM923XX
HSM933	HSM933XX
	HM933XX
HSM943	HSM943XX
	HM943XX
	XX = Date Code

Ordering Information



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